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Electronic Patent Application Submission  
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Application ID: 10766046



Title of Invention: LEADFRAME TYPE  
SEMICONDUCTOR PACKAGE  
HAVING REDUCED INDUCTANCE  
AND ITS MANUFACTURING  
METHOD

First Named Inventor: GI KIM

Domestic/Foreign Application: Domestic Application

Filing Date: 2004-01-28

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Statement

Filing Type:

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Attorney Docket Number: AMKOR099A

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**TRANSMITTAL**

Electronic Version v1.1  
Stylesheet Version v1.1.0

<b>Title of Invention</b>	<b>LEADFRAME TYPE SEMICONDUCTOR PACKAGE HAVING REDUCED INDUCTANCE AND ITS MANUFACTURING METHOD</b>									
<p>Application Number: 10/766046 </p> <p>Date: 2004-01-28</p> <p>First Named Applicant: GI JEONG KIM</p> <p>Confirmation Number: 2288</p> <p>Attorney Docket Number: AMKOR099A</p>										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>MARK B. GARRED Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney								
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Documents being submitted	Files									
us-ids	ids5-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
<b>Comments</b>										



# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of  
Invention

LEADFRAME TYPE SEMICONDUCTOR PACKAGE  
HAVING REDUCED INDUCTANCE AND ITS  
MANUFACTURING METHOD

Application Number: 10/766046



Confirmation Number: 2288

First Named Applicant: GI KIM

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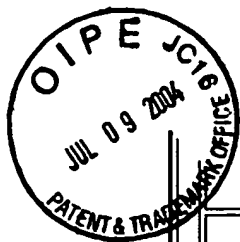
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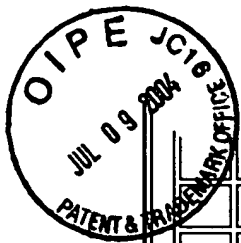
## US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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<input type="checkbox"/>	50	6339255	2002-01-15	Shin

Signature

Examiner Name	Date